



#### LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

### **Product Summary**

V <sub>BR (min)</sub>	I <sub>PP (max)</sub>	C <sub>T (typ)</sub>
6.0V	4A	8pF

### **Description**

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras and MP3 players.

#### **Applications**

- Cellular Handsets
- Portable Electronics
- · Computers and Peripheral

#### **Features**

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6 \* 0.3 \* 0.3mm)
- Provides ESD Protection per IEC 61000-4-2 Standard:

Air ±17kV, Contact ±15kV

- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin over Copper leadframe, solderable per MIL-STD-202, Method 208 63
- Weight: 0.0002 grams (approximate)







**Bottom View** 



**Device Schematic** 

### **Ordering Information (Note 4)**

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D5V0P1B2LP3-7	Standard	6/9	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**

6/9

6/9 = Product Type Marking Code Bar Denotes Cathode Side



### Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I <sub>PP</sub>	4	Α	8/20µs, per Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±15	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V <sub>ESD_Air</sub>	±17	kV	IEC 61000-4-2 Standard

## **Thermal Characteristics**

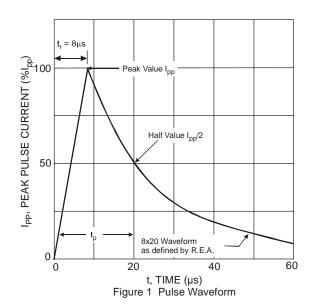
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	$P_{D}$	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	$V_{RWM}$	_	_	5.5	V	_
Channel Leakage Current (Note 6)	I <sub>RM</sub>	_	10	100	nA	V <sub>RWM</sub> = 5V
Clamping Voltage, Positive Transients	V <sub>CL</sub>	_	7.0	9.0	V	$I_{PP} = 1A$ , tp = 8/20µS, Figure 3
		_	11.0	13.0		$I_{PP} = 4A$ , $tp = 8/20\mu S$ , Figure 3
Breakdown Voltage	$V_{BR}$	6	7	8	V	$I_R = 1mA$
Channel Input Capacitance	C <sub>T</sub>	_	8	10	pF	$V_R = 0V$ , $f = 1MHz$

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.



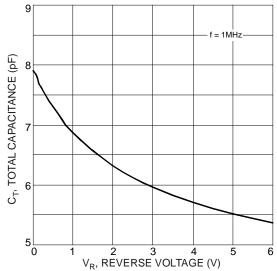
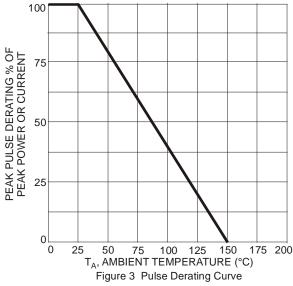
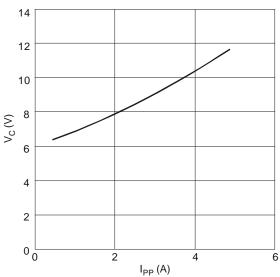


Figure 2 Typical Total Capacitance vs. Reverse Voltage







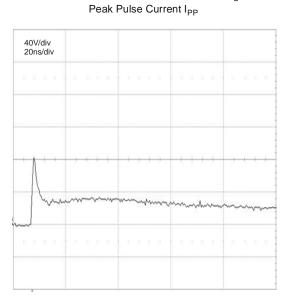


Figure 5 Typical Peak Clamping Voltage  $V_{\rm C}$  vs.

Figure 7 IEC 6100-4-2 Clamping Voltage +8kV Contact

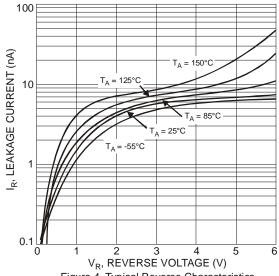


Figure 4 Typical Reverse Characteristics

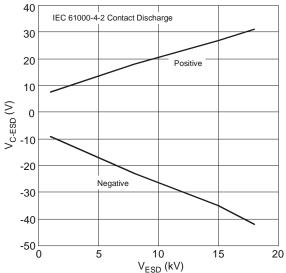


Figure 6 Typical Clamping Voltage vs. Contact Discharge Voltage

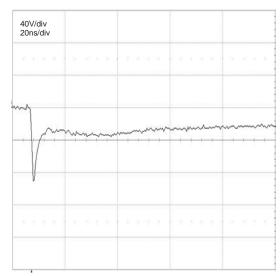
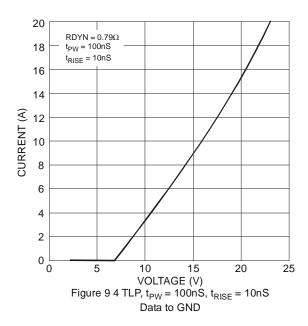


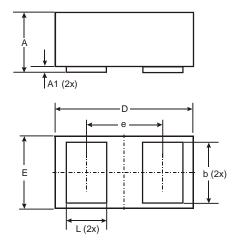
Figure 8 IEC 6100-4-2 Clamping Voltage -8kV Contact





## **Package Outline Dimensions**

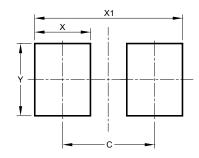
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



X3-DFN0603-2						
Dim	Min	Max	Тур			
Α	0.27	0.35	0.30			
A1	0.00	0.03	0.02			
b	0.19	0.29	0.24			
D	0.595	0.645	0.62			
Е	0.295	0.345	0.32			
е	-	-	0.355			
L	0.14	0.24	0.19			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	0.380		
Х	0.230		
X1	0.610		
Υ	0.300		



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